

Smart Power High-Side-Switch





Features

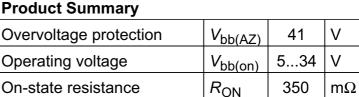
- Overload protection
- Current limitation
- Short circuit protection
- Thermal shutdown with restart
- Overvoltage protection (including load dump)
- Fast demagnetization of inductive loads
- Reverse battery protection with external resistor
- Open drain diagnostic output
- CMOS compatible input
- Loss of GND and loss of V_{bb} protection
- ESD Protection
- Very low standby current
- AEC qualified
- Green product (RoHS compliant)

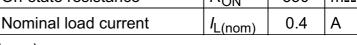
Application

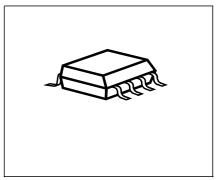
- All types of resistive, inductive and capacitive loads
- μC compatible power switch for 12 V and 24 V DC applications
- Replaces electromechanical relays and discrete circuits

General Description

N channel vertical power FET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, monolithically integrated in Smart SIPMOS® technology. Providing embedded protective functions.



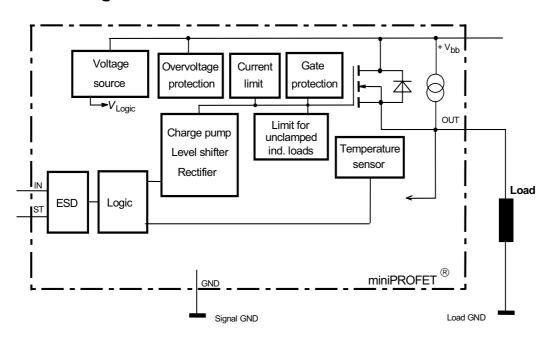




PG-DSO8

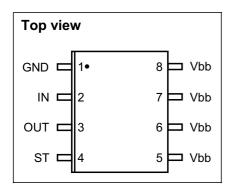


Block Diagram



Pin	Symbol	Function
1	GND	Logic ground
2	IN	Input, activates the power switch in case of logic high signal
3	OUT	Output to the load
4	ST	Diagnostic feedback
5	Vbb	Positive power supply voltage
6	Vbb	Positive power supply voltage
7	Vbb Positive power supply voltage	
8	Vbb	Positive power supply voltage

Pin configuration



Data Sheet 2 V1.1, 2007-05-29



Smart High-Side Power Switch BSP742RI

Maximum Ratings at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Supply voltage	$V_{\rm bb}$	40	V
Supply voltage for full short circuit protection	V _{bb(SC)}	$V_{ m bb}$	
Continuous input voltage	V_{IN}	-10 +16	
Load current (Short - circuit current, see page 5)	I_{L}	self limited	Α
Current through input pin (DC)	I _{IN}	± 5	mA
Operating temperature	T_{j}	-40+150	°C
Storage temperature	$T_{\rm stg}$	-55 + 150	
Power dissipation ¹⁾	P _{tot}	1.5	W
Inductive load switch-off energy dissipation 1)2)	E _{AS}	800	mJ
single pulse, (see page 9)			
Tj =150 °C, V_{bb} = 13.5 V, I_{L} = 0.3 A			
Load dump protection ²⁾ $V_{\text{LoadDump}}^{3} = V_{\text{A}} + V_{\text{S}}$	V _{Loaddump}		V
$R_{\rm I}$ =2 Ω , $t_{\rm d}$ =400ms, $V_{\rm IN}$ = low or high, $V_{\rm A}$ =13,5 V			
R_{L} = 45 Ω		60	
Electrostatic discharge voltage (Human Body Model)	V _{ESD}		kV
according to ANSI EOS/ESD - S5.1 - 1993			
ESD STM5.1 - 1998			
Input pin		± 1	
all other pins		± 5	

Thermal Characteristics

Thermal resistance @ min. footprint	$R_{th(JA)}$	-	95	ı	K/W
Thermal resistance @ 6 cm ² cooling area ¹⁾	$R_{th(JA)}$	-	70	83	

Data Sheet 3 V1.1, 2007-05-29

¹Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm2 (one layer, 70µm thick) copper area for drain connection. PCB is vertical without blown air. (see page 17)

²not subject to production test, specified by design

 $^{^3}V_{
m Loaddump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839 .

Supply voltages higher than $V_{bb(AZ)}$ require an external current limit for the GND pin, e.g. with a 150Ω resistor in GND connection. A resistor for the protection of the input is integrated.



Electrical Characteristics

Parameter and Conditions	Symbol		Values		Unit
at T_i = -40+150°C, V_{bb} = 13,5V, unless otherwise specified		min.	typ.	max.	
Load Switching Capabilities and Characterist	ics				
On-state resistance	R _{ON}				mΩ
$T_{\rm j}$ = 25 °C, $I_{\rm L}$ = 0.3 A, $V_{\rm bb}$ = 940 V		-	250	350	
T _j = 150 °C		-	450	700	
Nominal load current	/ _{L(nom)}	0.4	-	-	Α
Device on PCB 1)2)					
$T_{\rm C}$ = 85 °C, $T_{\rm j} \le$ 150 °C					
Turn-on time to 90% V _{OUT}	t _{on}	-	-	140	μs
$R_{L} = 47 \Omega$, $V_{IN} = 0$ to 10 V					
Turn-off time to 10% V _{OUT}	$t_{\rm off}$	-	-	170	
$R_{L} = 47 \Omega$, $V_{IN} = 10 \text{ to } 0 \text{ V}$					
Slew rate on 10 to 30% V _{OUT} ,	dV/dt _{on}	_	-	2	V/µs
R_{L} = 47 Ω					
Slew rate off 70 to 40% V _{OUT} ,	-dV/dt _{off}	-	-	2	
R_{L} = 47 Ω					

Operating Parameters

Operating voltage	V _{bb(on)}	5	-	34	V
Undervoltage shutdown of charge pump	V _{bb(under)}	-	-	5	
Undervoltage restart of charge pump	V _{bb(u cp)}	-	-	5.5	
Standby current	I _{bb(off)}	-	-	26	μA
$V_{IN} = 0 \text{ V}$					
Leakage output current (included in Ibb(off))	I _{L(off)}	-	•	12	
Operating current	I _{GND}	-	-	1.3	mA
V_{IN} = high					

Data Sheet 4 V1.1, 2007-05-29

¹Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm2 (one layer, 70µm thick) copper area for drain connection. PCB is vertical without blown air. (see page 17)

 $^{2\}mbox{Nominal load current is limited by current limitation (see page 5)$



Smart High-Side Power Switch BSP742RI

Electrical Characteristics

Parameter and Conditions	Symbol		Values		Unit
at T_i = -40+150°C, V_{bb} = 13,5V, unless otherwise specified		min.	typ.	max.	
Protection Functions ¹⁾					
Initial peak short circuit current limit (pin 5 to 3)	I _{L(SCp)}				Α
$T_{\rm j}$ = -40 °C, $V_{\rm bb}$ = 20 V		-	-	2	
<i>T</i> _j = 25 °C		-	1.2	-	
<i>T</i> _j = 150 °C		0.4	ı	-	
Repetitive short circuit current limit	I _{L(SCr)}				
$T_j = T_{jt}$ (see timing diagrams)		-	1	-	
Output clamp (inductive load switch off)	V _{ON(CL)}	41	47	-	V
at $V_{\text{OUT}} = V_{\text{bb}} - V_{\text{ON(CL)}}$,					
$I_{\rm bb} = 4 \text{ mA}$					
Overvoltage protection ²⁾	$V_{\rm bb(AZ)}$	41	ı	-	
$I_{\rm bb}$ = 4 mA					
Thermal overload trip temperature	T_{jt}	150	-	-	°C
Thermal hysteresis	$\Delta T_{\rm jt}$	-	10	-	K

Reverse Battery

Reverse battery ³⁾	-V _{bb}	-	-	32	V
Drain-source diode voltage ($V_{OUT} > V_{bb}$)	-V _{ON}	-	600	-	mV
<i>T</i> _j = 150 °C					

Data Sheet 5 V1.1, 2007-05-29

¹Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

 $^{^{2}}$ see also $V_{\mbox{ON(CL)}}$ in circuit diagram on page 8

 $^{^3}$ Requires a 150 Ω resistor in GND connection. The reverse load current through the intrinsic drain-source diode has to be limited by the connected load. Power dissipation is higher compared to normal operating conditions due to the voltage drop across the drain-source diode. The temperature protection is not active during reverse current operation! Input current has to be limited (see max. ratings page 3).



Electrical Characteristics

Parameter	Symbol		Values		Unit
at T_j = -40+150°C, V_{bb} = 13,5V, unless otherwise specified		min.	typ.	max.	
Input and Status feedback					
Input turn-on threshold voltage	$V_{\rm IN(T+)}$	-	-	2.2	V
Input turn-off threshold voltage	$V_{\rm IN(T-)}$	0.8	-	-	
Input threshold hysteresis	$\Delta V_{\text{IN(T)}}$	ı	0.3	-	
Off state input current	/ _{IN(off)}	1	-	30	μΑ
$V_{IN} = 0.7 \text{ V}$, ,				
On state input current	I _{IN(on)}	1	-	30	
V _{IN} = 5 V					
Status output (open drain), Zener limit voltage	V _{ST(high)}	5.4	6.1	-	V
<i>I</i> _{ST} = 1.6 mA					
Status output (open drain), ST low voltage	V _{ST(low)}				
$T_{\rm j}$ = -40+25 °C, $I_{\rm ST}$ = 1.6 mA		-	-	0.4	
$T_{\rm j}$ = 150 °C, $I_{\rm ST}$ = 1.6 mA				0.6	
Status invalid after input slope 1)	$t_{d(ST)}$	-	300	600	μs
Input resistance (see page 8)	R_{I}	1.5	3.5	5	kΩ

Diagnostic Characteristics

Short circuit detection voltage	V _{OUT(SC)}	-	2.8	-	V
Open load detection voltage	V _{OUT(OL)}	-	3	-	
Openload detection current	I _{L(OL)}	-	5	-	μA
included in standby current $I_{bb(off)}$					

Data Sheet 6 V1.1, 2007-05-29

¹no delay time after overtemperature switch off and short circuit in on-state



	Input	Output	Status
	level	level	
Normal	L	L	L
operation	Η	Η	L
Short circuit	L	L	L
to GND	Н	L *	Н
Short circuit to	L	Н	Н
V _{bb} (in off-state)	Н	Н	L
Overload	L	L	L
	Н	H **	L
Overtemperature	L	L	L
	Н	L	Н
Open Load in	L	Н	Н
off-state	Н	Н	L

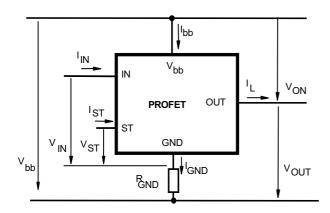
^{*)} Out ="L": V_{OUT} < 2V typ.

Data Sheet 7 V1.1, 2007-05-29

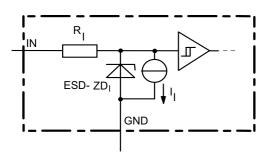
^{**)} Out ="H": $V_{OUT} > 2V \text{ typ.}$



Terms

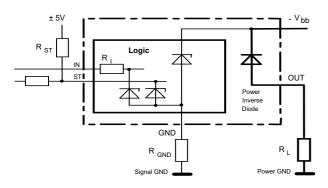


Input circuit (ESD protection)



The use of ESD zener diodes as voltage clamp at DC conditions is not recommended

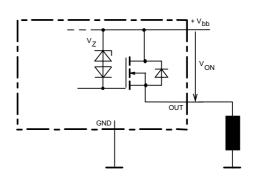
Reverse battery protection



 R_{GND} =150 Ω , R_{I} =3.5 $k\Omega$ typ.,

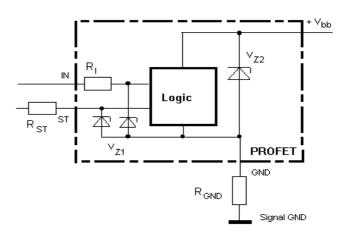
Temperature protection is not active during inverse current

Inductive and overvoltage output clamp



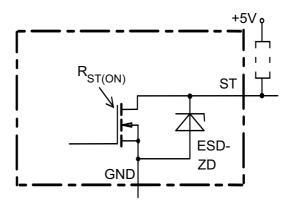
V_{ON} clamped to 47V typ.

Overvoltage protection of logic part



 $\begin{aligned} &V_{Z1}\text{=}6.1V \text{ typ., } V_{Z2}\text{=}V_{bb(AZ)}\text{=}47V \text{ typ.,} \\ &R_{I}\text{=}3.5 \text{ k}\Omega \text{ typ., } R_{GND}\text{=}150\Omega \end{aligned}$

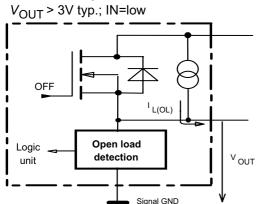
Status output



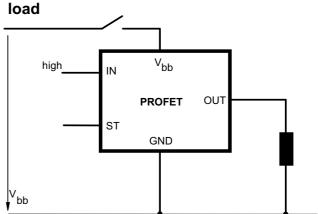


Open-load detection

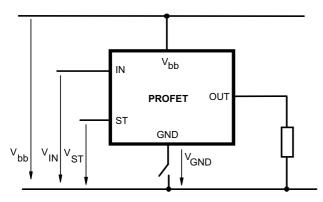
OFF-state diagnostic condition:



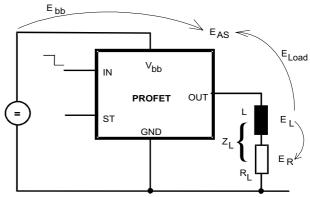
V_{bb} disconnect with charged inductive



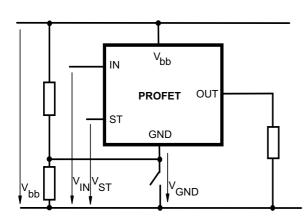
GND disconnect



Inductive Load switch-off energy dissipation



GND disconnect with GND pull up



Energy stored in load inductance: $E_L = \frac{1}{2} * L * I_L^2$ While demagnetizing load inductance, the energy dissipated in PROFET is $E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} * i_L(t) dt$, with an approximate solution for $R_L > 0\Omega$:

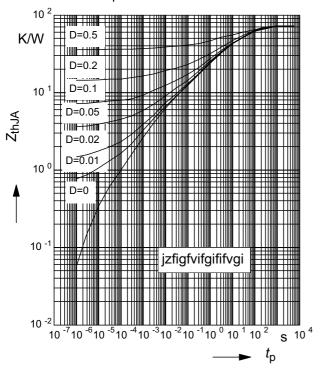
$$E_{AS} = \frac{I_L * L}{2 * R_L} * (V_{bb} + |V_{OUT(CL)|}) * ln(1 + \frac{I_L * R_L}{|V_{OUT(CL)}|})$$

Data Sheet 9 V1.1, 2007-05-29



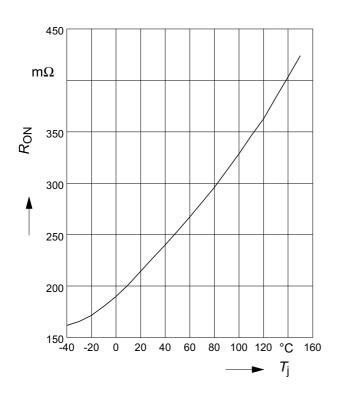
Typ. transient thermal impedance Z_{thJA} =f(t_p) @ 6cm² heatsink area

Parameter: $D=t_p/T$



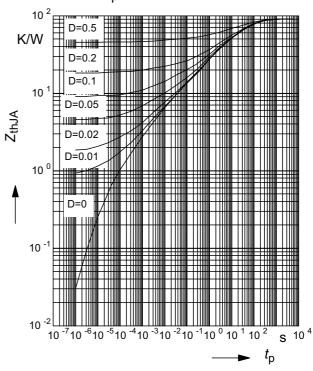
Typ. on-state resistance

$$R_{ON} = f(T_i)$$
; $V_{bb} = 13.5V$; $V_{in} = high$



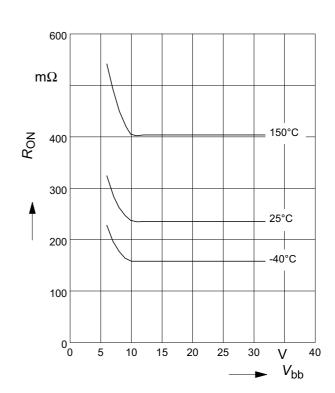
Typ. transient thermal impedance Z_{thJA} =f(t_p) @ minimal footprint

Parameter: $D=t_p/T$



Typ. on-state resistance

 $R_{ON} = f(V_{bb}); I_L = 0.3A; V_{in} = high$

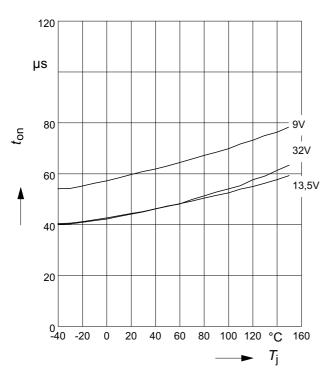


Data Sheet 10 V1.1, 2007-05-29

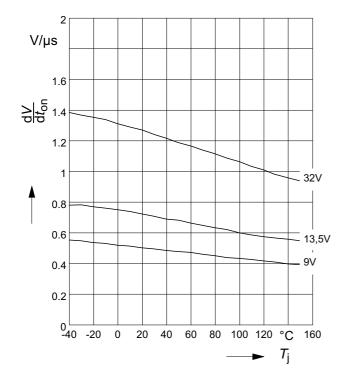


Typ. turn on time

$$t_{on} = f(T_j); R_L = 47\Omega$$

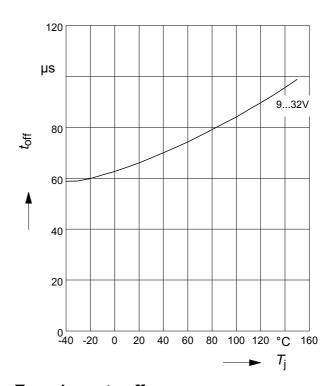


Typ. slew rate on $dV/dt_{on} = f(T_j)$; $R_L = 47 \Omega$



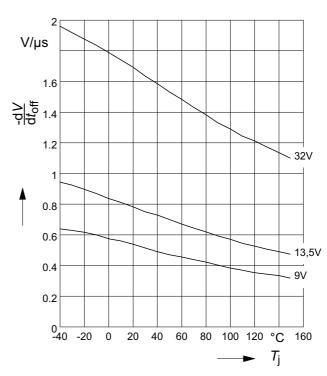
Typ. turn off time

$$t_{\text{off}} = f(T_j); R_L = 47\Omega$$



Typ. slew rate off

$$dV/dt_{off} = f(T_j); R_L = 47 \Omega$$

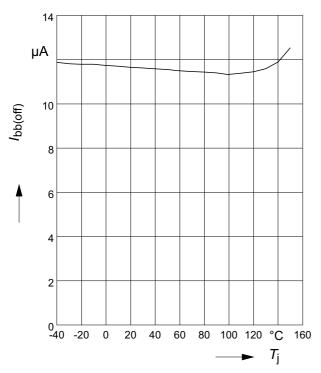


Data Sheet 11 V1.1, 2007-05-29

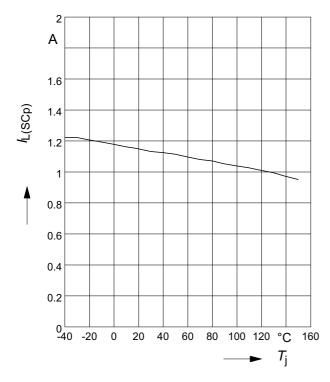


Typ. standby current

$$I_{bb(off)} = f(T_j)$$
; $V_{bb} = 32V$; $V_{IN} = low$

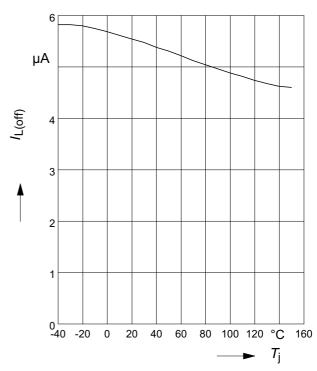


Typ. initial peak short circuit current limit $I_{L(SCp)} = f(T_i)$; $V_{bb} = 20V$



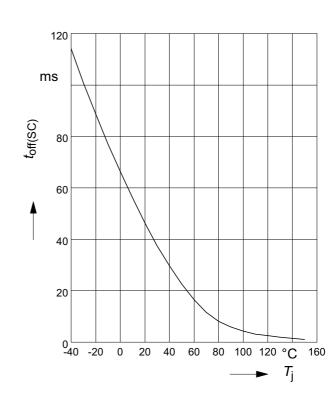
Typ. leakage current

$$I_{L(off)} = f(T_j)$$
; $V_{bb} = 32V$; $V_{IN} = low$



Typ. initial short circuit shutdown time

$$t_{\text{off(SC)}} = f(T_{\text{i,start}})$$
; $V_{\text{bb}} = 20V$

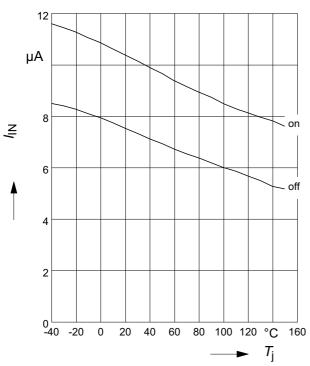


Data Sheet 12 V1.1, 2007-05-29



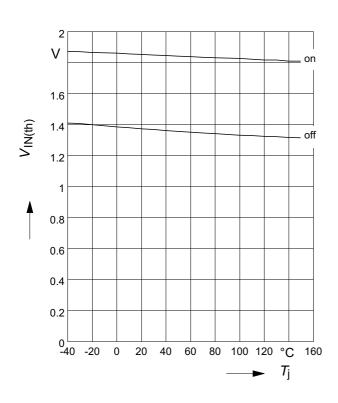
Typ. input current

 $I_{\text{IN(on/off)}} = f(T_j); V_{\text{bb}} = 13,5V; V_{\text{IN}} = \text{low/high}$ $V_{\text{INlow}} \le 0,7V; V_{\text{INhigh}} = 5V$



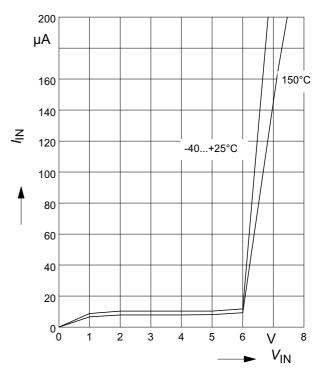
Typ. input threshold voltage

$$V_{IN(th)} = f(T_j)$$
; $V_{bb} = 13,5V$



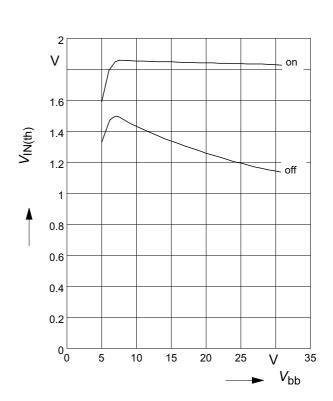
Typ. input current

 $I_{IN} = f(V_{IN}); V_{bb} = 13.5V$



Typ. input threshold voltage

 $V_{IN(th)}$ = f(V_{bb}); T_j = 25°C

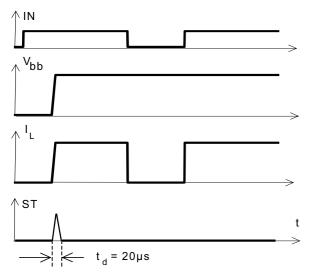


Data Sheet 13 V1.1, 2007-05-29



Timing diagrams

Figure 1a: Vbb turn on:



Invalid status during t_d

Figure 2b: Switching a lamp,

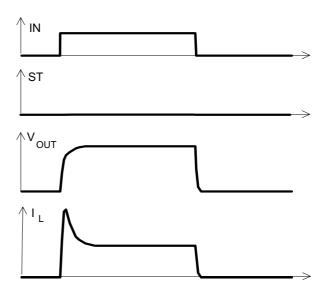


Figure 2a: Switching a resistive load, turn-on/off time and slew rate definition

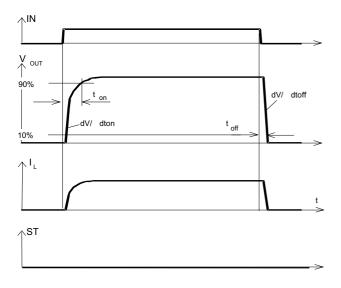
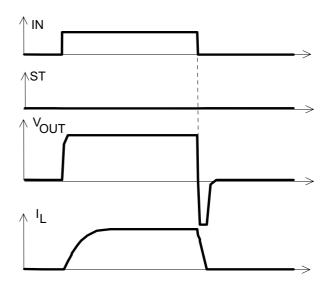
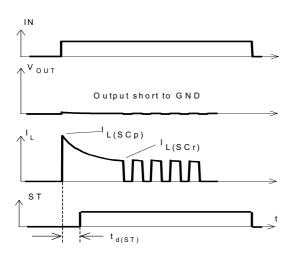


Figure 2c: Switching an inductive load



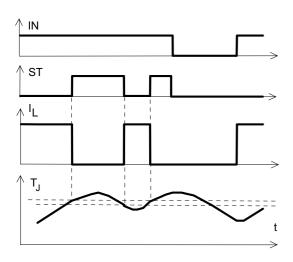
Data Sheet 14 V1.1, 2007-05-29





Heating up of the chip may require several milliseconds, depending on external conditions.

Figure 4: Overtemperature: Reset if $T_i < T_{it}$



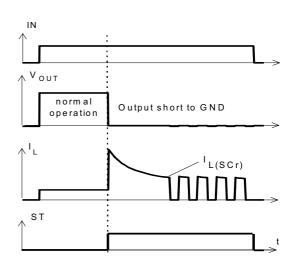
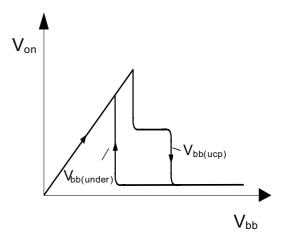


Figure 5: Undervoltage restart of charge pump





Package Outlines

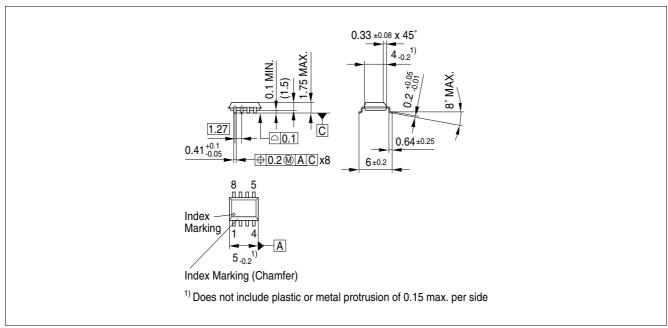


Figure 1 PG-DSO-8-24 (Plastic Dual Small Outline Package) (RoHS-compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order



Revision History

Version	Date	Changes
V1.1	2007-05-29	Creation of the green datasheet.
		First page :
		Adding the green logo and the AEC qualified
		Adding the bullet AEC qualified and the RoHS compliant features
		Package page
		Modification of the package to be green.

Edition 2007-05-29

Published by Infineon Technologies AG 81726 Munich, Germany © Infineon Technologies AG 5/29/07. All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie"). With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.